



Product Change Notification

113812 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113812 - 00
Change Title: Intel® Server Chassis P4304CR2LFKN
PCN 113812-00, Product Design, Label
Update the Safety label with an EAC logo
instead of a GOST logo and Change
Capacitor and Cable on PDB
Date of Publication: April 21, 2015

Key Characteristics of the Change:

Product Design, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	Apr 27, 2015
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Chassis P4304CR2LFKN:

1. Update the Safety Label: Put an EAC logo instead of a GOST logo for certification update. Please see Figure-1 and Figure-2 below for details.

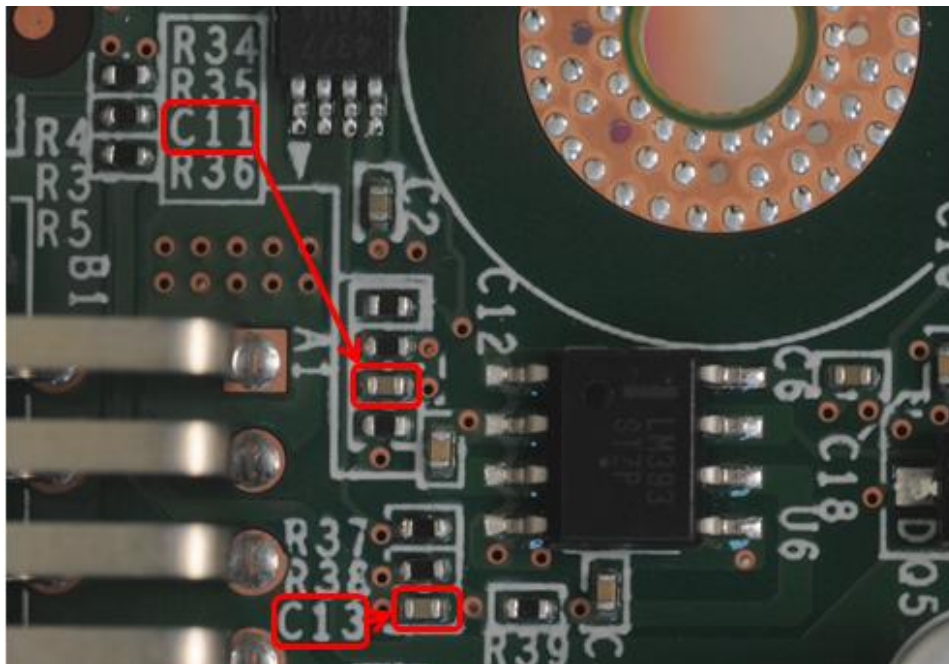


Figure-1: Pre-Change

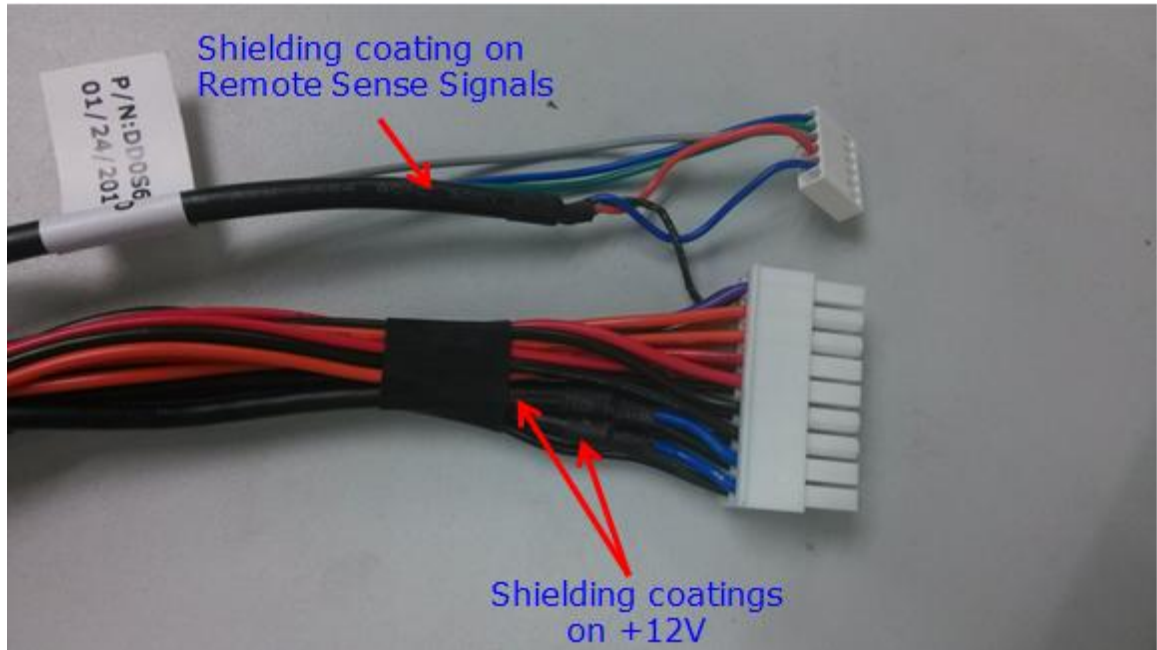


Figure-2: Post-Change

2. Increase the capacitor values of C11 and C13 from 0.1 μ F to 2.2 μ F for FUPPDBLC Power Distribution Board, to extend the duration of the Over Current Protection circuit from 0.6ms to 8.0ms.
Please refer to the TA-1056-01 for more details.



3. Add shielding coatings on the power rails of +12V and the remote sense signals respectively to prevent the noise coupling from the +12V signal wires to the remote sense signal wires.
Please refer to the TA-1047-01 for more details.



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
P4304CR2LFKN	916046	G34863-002	G34863-003

PCN Revision History:

Date of Revision:

April 21, 2015

Revision Number:

00

Reason:

Originally Published PCN